

### General Description

The 020N12 uses advanced trench technology and design to provide excellent RDS(ON). This device is ideal for PWM, load switching and general purpose applications.

### Features

- Low On-Resistance
- High Reliability Capability with Passivation
- 100% avalanche tested
- RoHS Compliant

### Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	120	V
$V_{GS}$	Gate-Source Voltage	$\pm 25$	V
$I_D@T_C=25^\circ C$	Continuous Drain Current	55	A
$I_D@T_C=100^\circ C$	Continuous Drain Current	45	A
$I_{DM}$	Pulsed Drain Current	165	A
EAS	Single Pulse Avalanche Energy <sup>1</sup>	65	mJ
$P_D@T_C=25^\circ C$	Total Power Dissipation	130	W
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ C$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ C$

### Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient (PCB mount) <sup>2</sup>	---	50	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction -Case	---	1.2	$^\circ C/W$

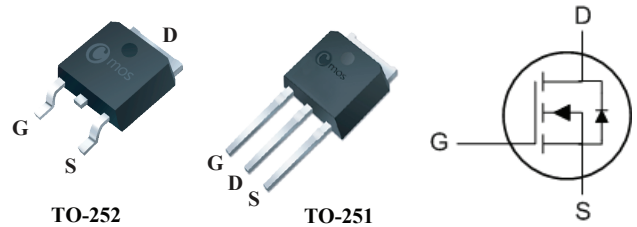
### Product Summary

BVDSS	RDSON	ID
120V	19m $\Omega$	55A

### Applications

- DC-DC Converters
- Power switching application

### TO-252/251 Pin Configuration



Type	Package	Marking
CMD020N12	TO-252	CMD020N12
CMU020N12	TO-251	CMU020N12

### Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	120	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=15A$	---	---	19	m $\Omega$
		$V_{GS}=6V, I_D=10A$	---	---	30	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	2	---	4	V
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=120V, V_{GS}=0V$	---	---	1	$\mu A$
		$V_{DS}=120V, V_{GS}=0V, T_J=55^\circ\text{C}$	---	---	5	
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 25V, V_{DS}=0V$	---	---	$\pm 100$	nA
$g_{fs}$	Forward Transconductance	$V_{DS}=10V, I_D=10A$	---	15	---	S
$R_g$	Gate Resistance	$V_{DS}=0V, V_{GS}=0V, f=1\text{MHz}$	---	3.2	---	$\Omega$
$Q_g$	Total Gate Charge	$V_{DS}=50V, V_{GS}=10V, I_D=25A$	---	35	---	nC
$Q_{gs}$	Gate-Source Charge		---	14	---	
$Q_{gd}$	Gate-Drain Charge		---	8	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=30V, V_{GEN}=10V, R_L=30\Omega$ $R_{GEN}=6\Omega, I_{DS}=1A$	---	20	---	ns
$T_r$	Rise Time		---	10	---	
$T_{d(off)}$	Turn-Off Delay Time		---	40	---	
$T_f$	Fall Time		---	22	---	
$C_{iss}$	Input Capacitance	$V_{DS}=30V, V_{GS}=0V, f=1\text{MHz}$	---	2200	---	pF
$C_{oss}$	Output Capacitance		---	230	---	
$C_{riss}$	Reverse Transfer Capacitance		---	50	---	

### Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_S$	Continuous Source Current	$V_G=V_D=0V$ , Force Current	---	---	55	A
$V_{SD}$	Diode Forward Voltage	$V_{GS}=0V, I_S=20A, T_J=25^\circ\text{C}$	---	---	1.2	V

Note :

- 1.The test condition is  $V_{DD}=30V, V_{GS}=10V, L=0.5\text{mH}, I_D=18A$
- 2.Surface mounted on 1 in2 copper pad of FR4 board

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